

NPN SILICON RF POWER TRANSISTOR

DESCRIPTION:

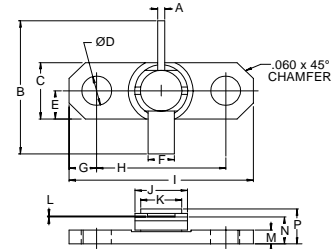
The **ASI 2307** is Designed for General Purpose Class C Power Amplifier Applications up to 3000 MHz.

FEATURES:

- $P_G = 9.5$ dB min. at 7.0 W/2300 MHz
- Hermetic Microstrip Package
- **Omnigold™** Metalization System

MAXIMUM RATINGS

I_C	1.2 A
V_{CC}	26 V
P_{DISS}	21.4 W @ $T_C \leq 50^\circ C$
T_J	$-65^\circ C$ to $+200^\circ C$
T_{STG}	$-65^\circ C$ to $+200^\circ C$
θ_{JC}	7.0 $^\circ C/W$

PACKAGE STYLE .250 2L FLG


DIM	MINIMUM inches / mm	MAXIMUM inches / mm
A	.028 / 0.71	.032 / 0.81
B	.740 / 18.80	
C	.245 / 6.22	.255 / 6.48
D	.128 / 3.25	.132 / 3.35
E		.125 / 3.18
F	.110 / 2.79	.117 / 2.97
G		.117 / 2.97
H	.560 / 14.22	.570 / 14.48
I	.790 / 20.07	.810 / 20.57
J	.225 / 5.72	.235 / 5.97
K	.165 / 4.19	.185 / 4.70
L	.003 / 0.08	.007 / 0.18
M	.058 / 1.47	.068 / 1.73
N	.119 / 3.02	.135 / 3.43
P	.149 / 3.78	.187 / 4.75

ORDER CODE: ASI10536
CHARACTERISTICS $T_C = 25^\circ C$

SYMBOL	TEST CONDITIONS		MINIMUM	TYPICAL	MAXIMUM	UNITS
BV_{CBO}	$I_C = 1.0$ mA		44			V
BV_{CER}	$I_C = 5.0$ mA	$R_{BE} = 10 \Omega$	44			V
BV_{EBO}	$I_E = 1.0$ mA		3.5			V
I_{CBO}	$V_{CB} = 22$ V				0.5	mA
h_{FE}	$V_{CE} = 5.0$ V	$I_C = 500$ mA	30		300	---
C_{ob}	$V_{CB} = 22$ V	$f = 1.0$ MHz			8.5	pF
P_G η_c	$V_{CC} = 22$ V	$P_{OUT} = 7.0$ W	9.5 33			dB %